

# **Customer Information Notification**

Issue Date: 04-Sep-2016 Effective Date: 05-Sep-2016

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

## 2016080291



## **Change Category**

[] Wafer Fab	[] Assembly	[] Product Marking	[] Test	[] Design
Process	Process		Location	
[] Wafer Fab	[X] Assembly	[] Mechanical Specification	[]Test Process	[]Errata
Materials	Materials			
[] Wafer Fab	[X] Assembly	[]	[] Test	[] Electrical spec./Test
Location	Location	Packing/Shipping/Labeling	Equipment	coverage

# Error Correction for Freescale PCN 16961

#### **Information Notification**

NXP Semiconductor announces an error correction for Freescale PCN 16961.

For HC05B6, HC11E0, HC11E1, HC11E9, the leadframe size for copper wire in new assembly site ATP1 announced previously as 6.35mm x 6.35mm has been corrected to 9.02mm x 9.02mm to match the actual material.

This error correction does not affect the qualification results.

Why do we issue this Information Notification

Error correction for Freescale PCN 16961.

**Identification of Affected Products** 

Product identification does not change

# **Impact**

no impact to the product's functionality anticipated.

#### **Data Sheet Revision**

No impact to existing datasheet

## **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

NameJessie HaoPositionProduct Engineere-mail addressXiu.hao@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

### **About NXP Semiconductors**

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

NXP | Privacy Policy | Terms of Use

NXP Semiconductors

High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.

Changed Orderable Part# MCHC11F1CFNE3	Changed Part 12NC MCHC11F1CFNE3	Changed Part Number MCHC11F1CFNE3	Changed Part Description 8-BIT MCU,1KRAM,512EE,A/	Package Outline PLCC 68	Package Name PLCC 68	Status RFS	Product Line BL Microcontrollers
MC68HC11E1CFNE3	MC68HC11E1CFNE3	MC68HC11E1CFNE3	8 BIT MCU, 512 BYTES EE	PLCC 52	PLCC 52	RFS	BL Microcontrollers
MC68HC11E1MFNE3	MC68HC11E1MFNE3	MC68HC11E1MFNE3	8BIT MCU,512 BYTES RAM	PLCC 52	PLCC 52	RFS	BL Microcontrollers
MC68711E20CFNE2	MC68711E20CFNE2	MC68711E20CFNE2	8BIT, 20K EPROM, 768RAM	PLCC 52	PLCC 52	RFS	BL Microcontrollers
MC68HC11E0CFNE2	MC68HC11E0CFNE2	MC68HC11E0CFNE2	8BIT MCU, 512 BYTES RAM	PLCC 52	PLCC 52	RFS	BL Microcontrollers
MCHC11F1CFNE2	MCHC11F1CFNE2	MCHC11F1CFNE2	8-BIT MCU,1KRAM,512EE,A/	PLCC 68	PLCC 68	RFS	BL Microcontrollers
MCHC11F1CFNE4	MCHC11F1CFNE4	MCHC11F1CFNE4	8-BIT MCU,1KRAM,512EE,A/	PLCC 68	PLCC 68	RFS	BL Microcontrollers
MC68711E20CFNE3	MC68711E20CFNE3	MC68711E20CFNE3	8BIT, 20K EPROM, 768RAM	PLCC 52	PLCC 52	RFS	BL Microcontrollers